



FINAL PRODUCT/PROCESS CHANGE NOTIFICATION #16809Generic Copy

Issue Date: 23-May-2013

TITLE: Dual sourcing of NCV7420D24R2G (C615, Tape), NCV7420D24G (C615, Tube), NCV7420D26R2G (C616, Tape) and NCV7420D26G (C616, Tube) (I3T80 technology; currently only produced in Fab2) to also manufacture these devices in Gresham

PROPOSED FIRST SHIP DATE: Q4 2013 or earlier based upon customer agreement and request

AFFECTED CHANGE CATEGORY(S): Wafer Fab Manufacturing

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or your Customer Quality interface

SAMPLES: Contact your local ON Semiconductor Sales Office

ADDITIONAL RELIABILITY DATA: Available

Contact your local ON Semiconductor Sales Office or your Customer Quality interface

NOTIFICATION TYPE:

Final Product/Process Change Notification (FPCN)

Final change notification sent to customers. FPCNs are issued at least 90 days prior to implementation of the change.

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact <quality@onsemi.com>.

DESCRIPTION AND PURPOSE:

Release of NCV7420D24R2G (C615, Tape), NCV7420D24G (C615, Tube), NCV7420D26R2G (C616, Tape) and NCV7420D26G (C616, Tube) manufacturing in Gresham to increase ON Semi's wafer fab capacity for this device (dual sourcing)

List of affected General Parts:

ONSEMI Sellable Code
NCV7420D24R2G (C615, Tape)
NCV7420D24G (C615, Tube)
NCV7420D26R2G (C616, Tape)
NCV7420D26G (C616, Tube)